

UNISONIC TECHNOLOGIES CO., LTD

5N40 **Power MOSFET**

5A, 400V **N-CHANNEL POWER MOSFET**

DESCRIPTION

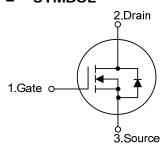
The UTC 5N40 is an N-channel mode power MOSFET using UTC's advanced technology to provide customers with planar stripe and DMOS technology. This technology specializes in allowing a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

The UTC 5N40 is universally applied in electronic lamp ballast based on half bridge topology and high efficient switched mode power supply.

FEATURES

- * $R_{DS(ON)}$ <1.20 @ V_{GS} =10V
- * High switching speed
- * 100% avalanche tested

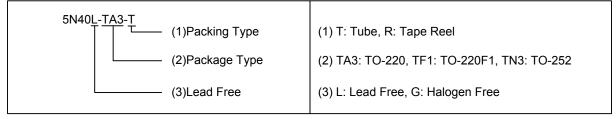
SYMBOL



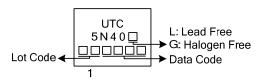
ORDERING INFORMATION

	Ordering Number		Dookogo	Pin	Dooking			
	Lead Free	Halogen Free	Package	1	2	3	Packing	
	5N40L-TA3-T	5N40L-TA3-T 5N40G-TA3-T		G	D	S	Tube	
ſ	5N40L-TF1-T	5N40G-TF1-T	TO-220F1	G	D	S	Tube	
	5N40L-TN3-R	5N40G-TN3-R	TO-252	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate S: Source D: Drain



MARKING



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TO-220

TO-220F1

TO-252

5N40 Power MOSFET

■ **ABSOLUTE MAXIMUM RATINGS** (T_C=25°C, unless otherwise specified)

PARAME	TER	SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V_{DSS}	400	V	
Gate-Source Voltage		V_{GSS}	±30	V	
Drain Current	Continuous (T _C =25°C)	I_{D}	5	Α	
Drain Current	Pulsed (Note 2)	I_{DM}	20	Α	
Avalanche Current (Note 2)		I_{AR}	5	Α	
Avalancha Energy	Single Pulsed (Note 3)	E _{AS}	300	mJ	
Avalanche Energy	Repetitive (Note 2)	E_{AR}	7.3	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.5	V/ns	
	TO-220		69	W	
Power Dissipation	TO-220F1	P_{D}	38	W	
	TO-252		54	W	
Junction Temperature	_	T_J	+150	°C	
Storage Temperature		T _{STG}	-55~+150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature
- 3. L = 21.5mH, I_{AS} = 5A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25 $^{\circ}$ C
- 4. $I_{SD} \le 5A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL DATA

PARA	AMETER	SYMBOL RATINGS		UNIT	
Junction to Ambien	TO-220/TO-220F1	0	62.5	°C/W	
	TO-252	θ_{JA}	110		
	TO-220		1.8	°C/W	
Junction to Case	TO-220F1	θ_{JC}	3.25		
	TO-252		2.13		

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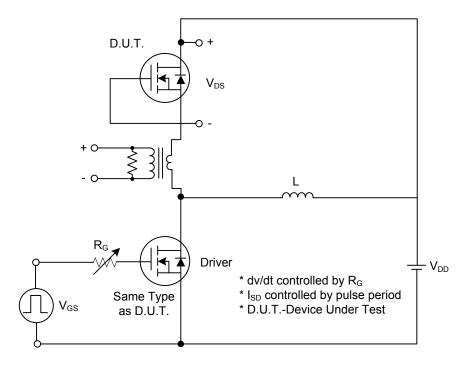
■ **ELECTRICAL CHARACTERISTICS** (T_C=25°C, unless otherwise noted)

PARAMETER		SYMBOL	TEST CONDITIONS MIN		TYP	MAX	UNIT		
OFF CHARACTERISTICS						•			
Drain-Source Breakdown Voltage	9	BV _{DSS}	I _D =250μA, V _{GS} =0V				V		
Breakdown Voltage Temperature Coefficient		△BV _{DSS} /△T _J	Reference to 25°C, I _D =250μA		0.4		V/°C		
Drain-Source Leakage Current		I _{DSS}	V _{DS} =400V, V _{GS} =0V			1	μA		
Gate- Source Leakage Current Reverse		I _{GSS}	V _{GS} =+30V, V _{DS} =0V V _{GS} =-30V, V _{DS} =0V			+100	nA nA		
ON CHARACTERISTICS									
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2.0		4.0	V		
Static Drain-Source On-State Resistance		R _{DS(ON)}	V _{GS} =10V, I _D =2.5A		0.96	1.2	Ω		
DYNAMIC PARAMETERS									
Input Capacitance		C _{ISS}			480	625	pF		
Output Capacitance		Coss	V _{GS} =0V, V _{DS} =25V, f=1.0MHz		80	105	pF		
Reverse Transfer Capacitance		C _{RSS}			15	20	pF		
SWITCHING PARAMETERS									
Total Gate Charge		Q_G	V _{GS} =10V, V _{DS} =320V, I _D =5A		18	24	nC		
Gate to Source Charge		Q_{GS}	(Note 1, 2)		2.2		nC		
Gate to Drain Charge		Q_{GD}	(NOIC 1, 2)		9.7		nC		
Turn-ON Delay Time		t _{D(ON)}	V _{DD} =200V, I _D =5A, R _G =25Ω		12	35	ns		
Rise Time		t _R			46	100	ns		
Turn-OFF Delay Time		t _{D(OFF)}	(Note 1, 2)		50	110	ns		
Fall-Time		t _F			48	105	ns		
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS									
Maximum Body-Diode Continuou	us Current	I _S				5	Α		
Maximum Body-Diode Pulsed Current		I _{SM}				20	Α		
Drain-Source Diode Forward Voltage		V_{SD}	I _S =5A, V _{GS} =0V			1.4	V		
Body Diode Reverse Recovery Time		t _{rr}	I _S =5A, V _{GS} =0V, dI _F /dt=100A/µs		263		ns		
Body Diode Reverse Recovery C	Charge	Q_{RR}	(Note 1)		1.9		μC		

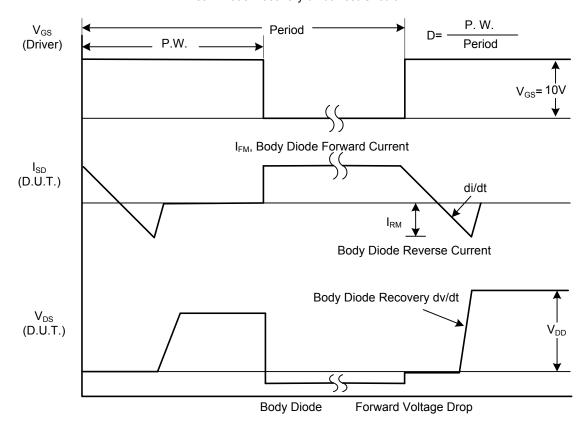
Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%

^{2.} Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

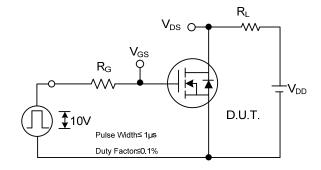


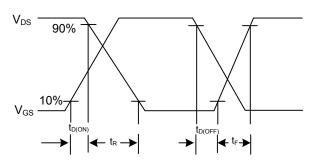
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

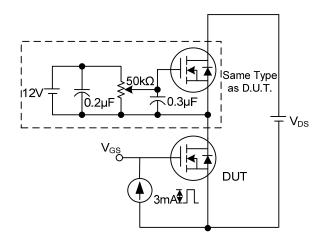
■ TEST CIRCUITS AND WAVEFORMS (Cont.)

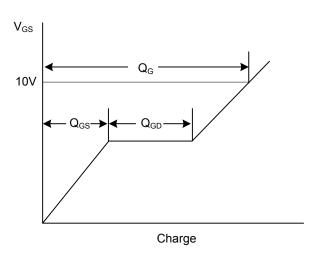




Switching Test Circuit

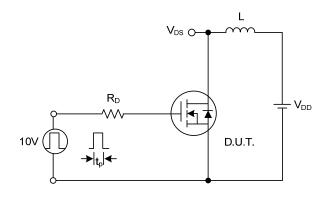
Switching Waveforms

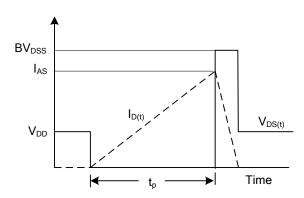




Gate Charge Test Circuit

Gate Charge Waveform

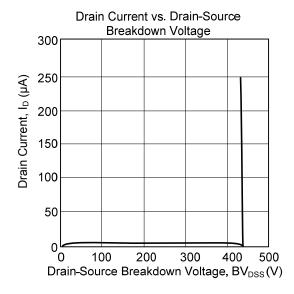


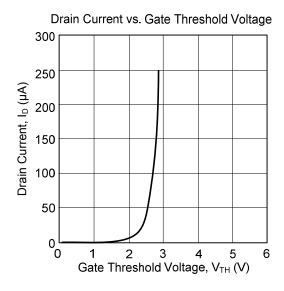


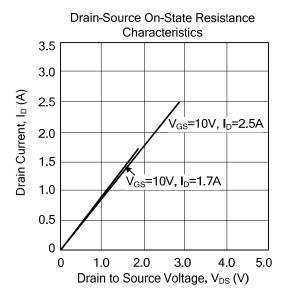
Unclamped Inductive Switching Test Circuit

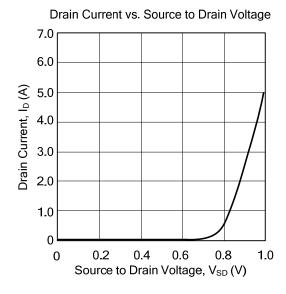
Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS









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